

## P-Channel Enhancement Mode Power MOSFET

**Description**

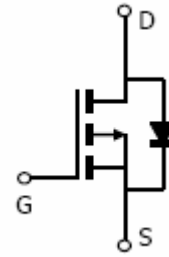
The PED55P5 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

**General Features**

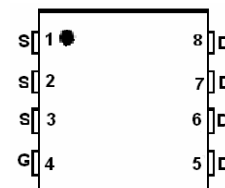
- $V_{DS} = -55V, I_D = -5A$   
 $R_{DS(ON)} < 80m\Omega @ V_{GS} = -10V$
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

**Application**

- Power switching application
- Hard switched and high frequency circuits
- DC-DC Converter



Schematic diagram



Marking and pin assignment



DFN 3x3 EP top view

**Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

| Parameter                                             | Symbol                   | Limit      | Unit             |
|-------------------------------------------------------|--------------------------|------------|------------------|
| Drain-Source Voltage                                  | $V_{DS}$                 | -55        | V                |
| Gate-Source Voltage                                   | $V_{GS}$                 | $\pm 20$   | V                |
| Drain Current-Continuous                              | $I_D$                    | -5         | A                |
| Drain Current-Continuous( $T_C = 100^\circ\text{C}$ ) | $I_D(100^\circ\text{C})$ | -3.0       | A                |
| Pulsed Drain Current                                  | $I_{DM}$                 | -25        | A                |
| Maximum Power Dissipation                             | $P_D$                    | 3          | W                |
| Operating Junction and Storage Temperature Range      | $T_J, T_{STG}$           | -55 To 150 | $^\circ\text{C}$ |

## Thermal Characteristic

|                                                 |                 |    |                      |
|-------------------------------------------------|-----------------|----|----------------------|
| Thermal Resistance ,Junction-to-Ambient(Note 2) | $R_{\theta JA}$ | 42 | $^{\circ}\text{C/W}$ |
|-------------------------------------------------|-----------------|----|----------------------|

## Electrical Characteristics ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

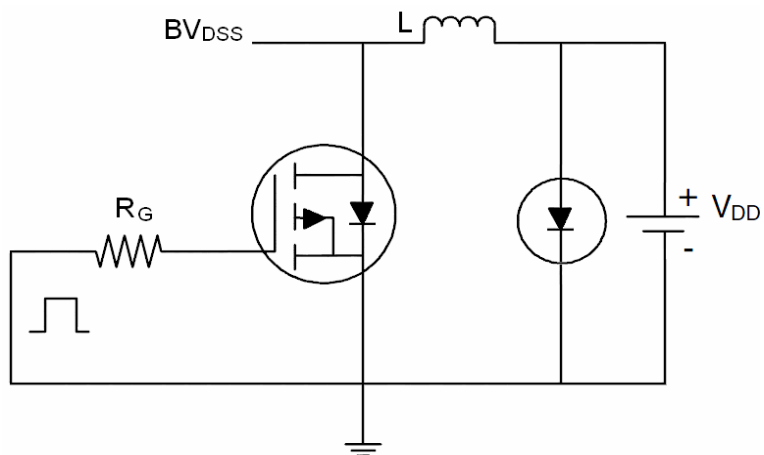
| Parameter                          | Symbol              | Condition                                                                                  | Min  | Typ  | Max  | Unit |
|------------------------------------|---------------------|--------------------------------------------------------------------------------------------|------|------|------|------|
| Off Characteristics                |                     |                                                                                            |      |      |      |      |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =-250μA                                                 | -55  | -    | -    | V    |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    | V <sub>DS</sub> =-55V, V <sub>GS</sub> =0V                                                 | -    | -    | 1    | μA   |
| Gate-Body Leakage Current          | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                                 | -    | -    | ±100 | nA   |
| On Characteristics (Note 3)        |                     |                                                                                            |      |      |      |      |
| Gate Threshold Voltage             | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA                                  | -1.5 | -2.6 | -3.5 | V    |
| Drain-Source On-State Resistance   | R <sub>DS(ON)</sub> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-5A                                                 | -    | 64   | 80   | mΩ   |
| Forward Transconductance           | g <sub>FS</sub>     | V <sub>DS</sub> =-15V, I <sub>D</sub> =-5A                                                 | 16   | -    | -    | S    |
| Dynamic Characteristics (Note4)    |                     |                                                                                            |      |      |      |      |
| Input Capacitance                  | C <sub>ISS</sub>    | V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V,<br>F=1.0MHz                                    | -    | 1450 | -    | PF   |
| Output Capacitance                 | C <sub>OSS</sub>    |                                                                                            | -    | 145  | -    | PF   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    |                                                                                            | -    | 110  | -    | PF   |
| Switching Characteristics (Note 4) |                     |                                                                                            |      |      |      |      |
| Turn-on Delay Time                 | t <sub>d(on)</sub>  | V <sub>DD</sub> =-30V, ,R <sub>L</sub> =30Ω<br>V <sub>GS</sub> =-10V, R <sub>GEN</sub> =6Ω | -    | 8    | -    | nS   |
| Turn-on Rise Time                  | t <sub>r</sub>      |                                                                                            | -    | 9    | -    | nS   |
| Turn-Off Delay Time                | t <sub>d(off)</sub> |                                                                                            | -    | 65   | -    | nS   |
| Turn-Off Fall Time                 | t <sub>f</sub>      |                                                                                            | -    | 30   | -    | nS   |
| Total Gate Charge                  | Q <sub>g</sub>      | V <sub>DS</sub> =-30V, I <sub>D</sub> =-5A,<br>V <sub>GS</sub> =-10V                       | -    | 26   | -    | nC   |
| Gate-Source Charge                 | Q <sub>gs</sub>     |                                                                                            | -    | 4.5  | -    | nC   |
| Gate-Drain Charge                  | Q <sub>gd</sub>     |                                                                                            | -    | 7    | -    | nC   |
| Drain-Source Diode Characteristics |                     |                                                                                            |      |      |      |      |
| Diode Forward Voltage (Note 3)     | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =-3A                                                   | -    | -    | 1.2  | V    |
| Diode Forward Current (Note 2)     | I <sub>S</sub>      |                                                                                            | -    | -    | -5   | A    |

## Notes:

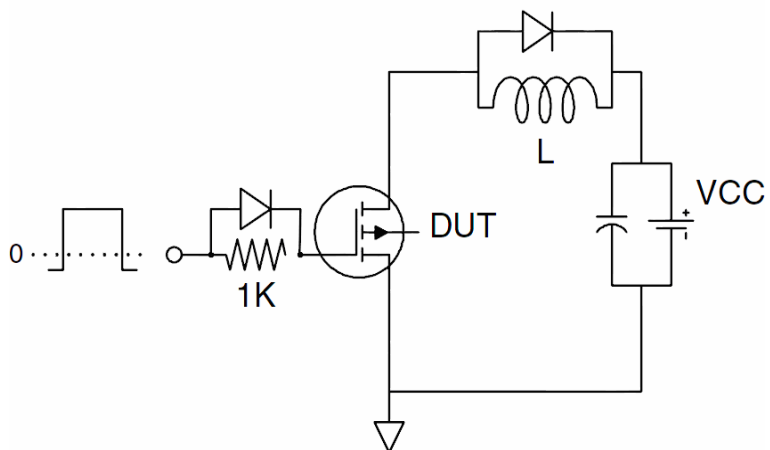
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

## Test Circuit

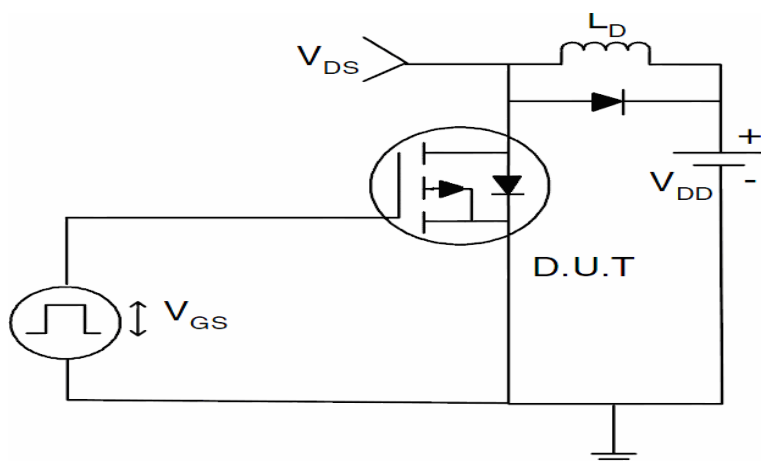
### 1) $E_{AS}$ Test Circuit



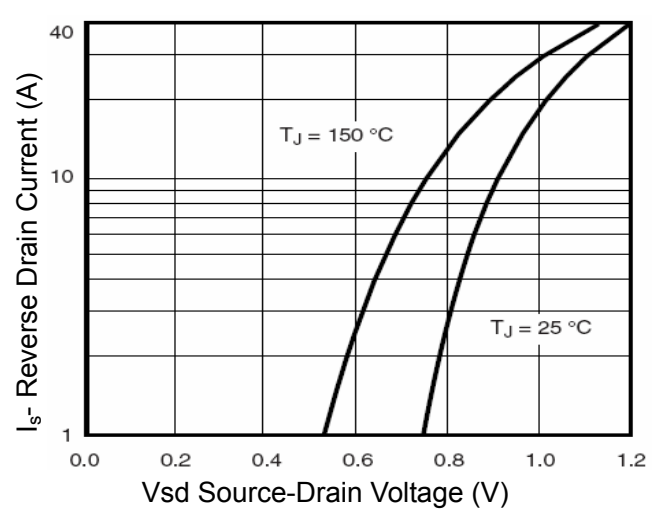
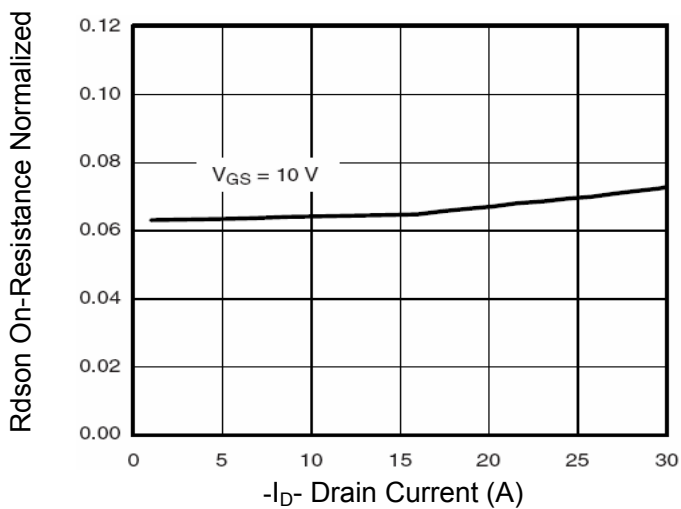
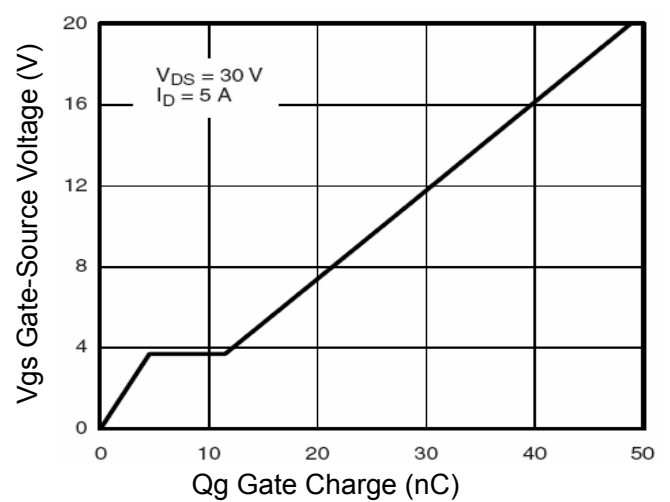
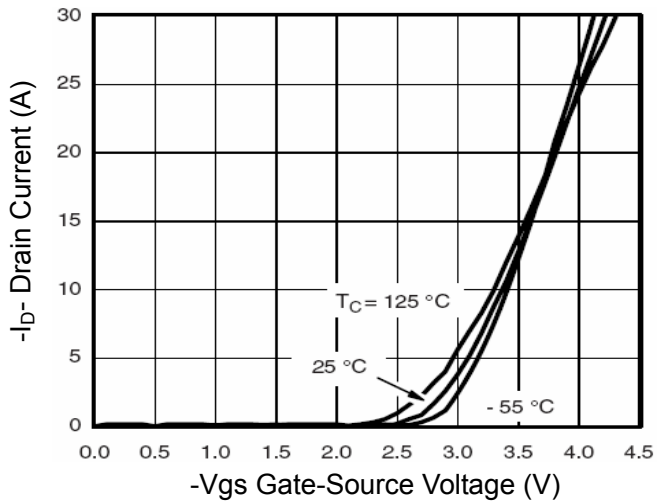
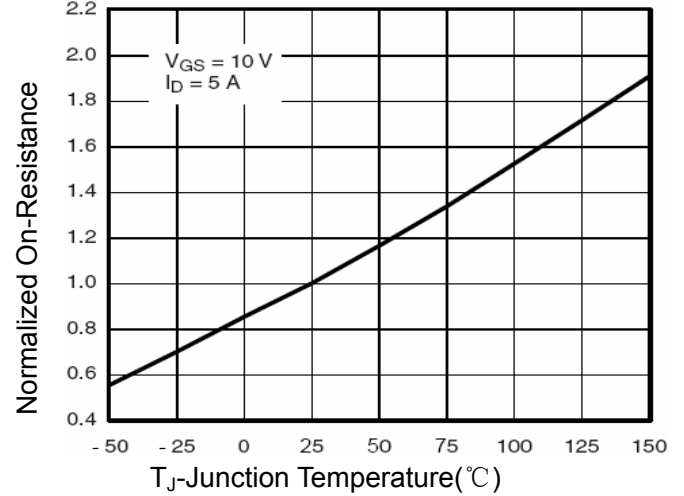
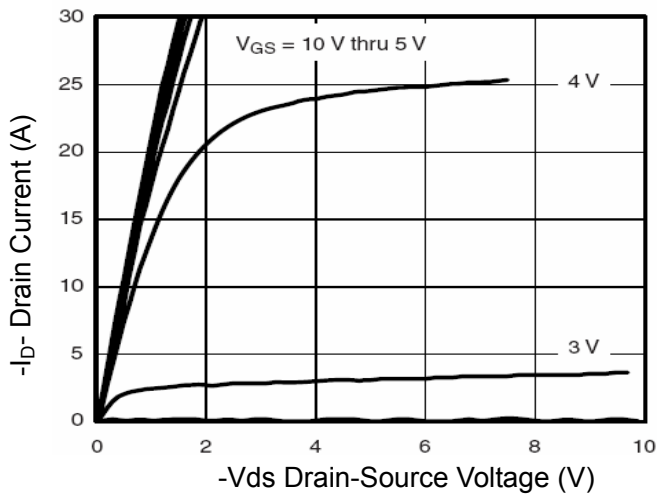
### 2) Gate Charge Test Circuit



### 3) Switch Time Test Circuit



# Typical Electrical and Thermal Characteristics (Curves)



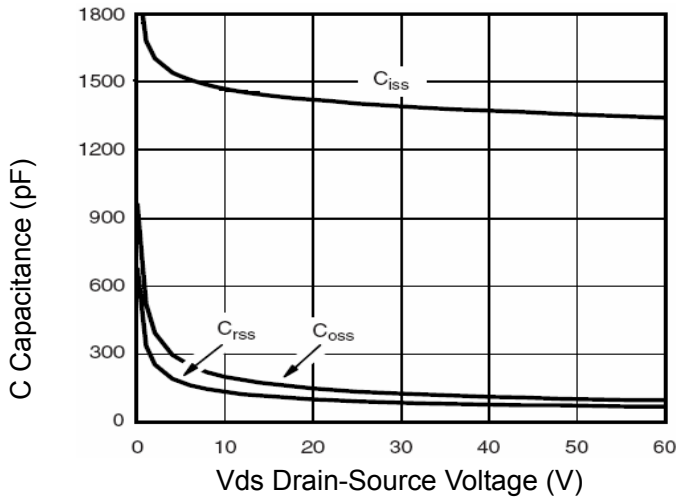


Figure 7 Capacitance vs Vds

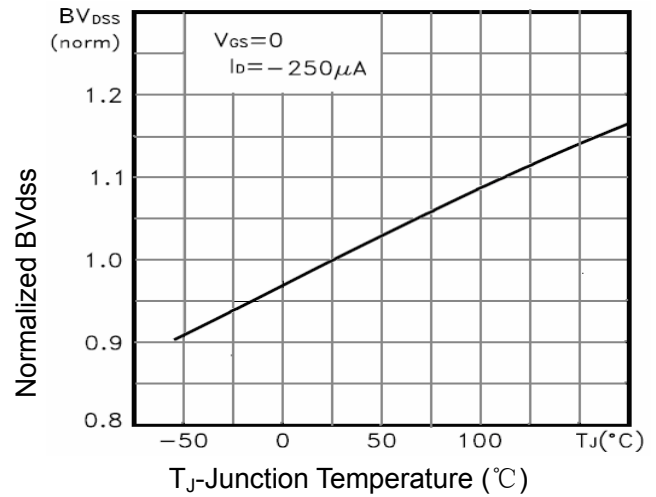


Figure 9  $BV_{DSS}$  vs Junction Temperature

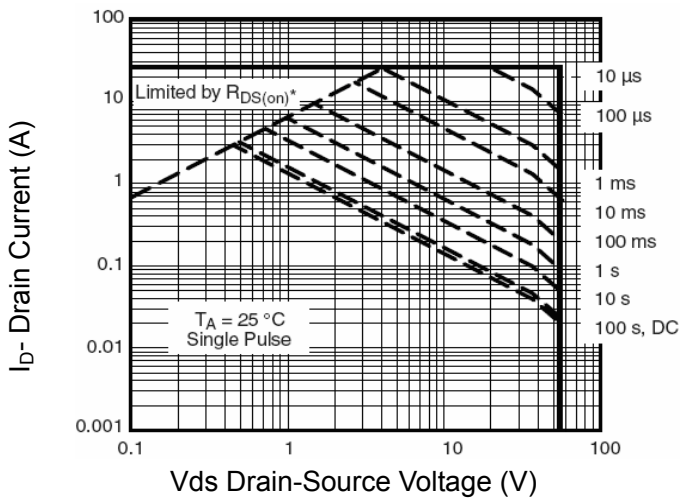


Figure 8 Safe Operation Area

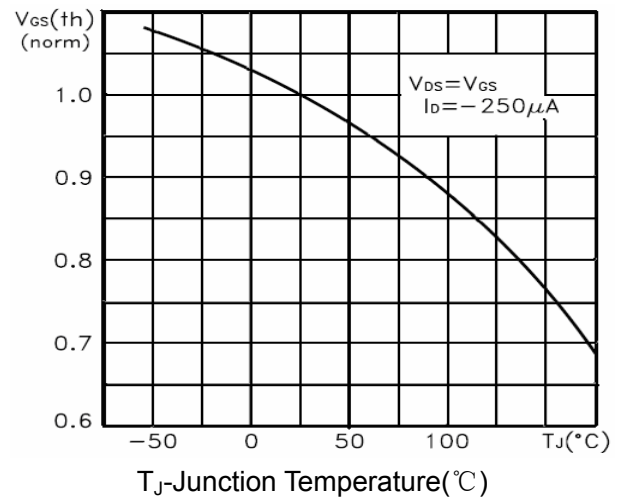


Figure 10  $V_{GS(th)}$  vs Junction Temperature

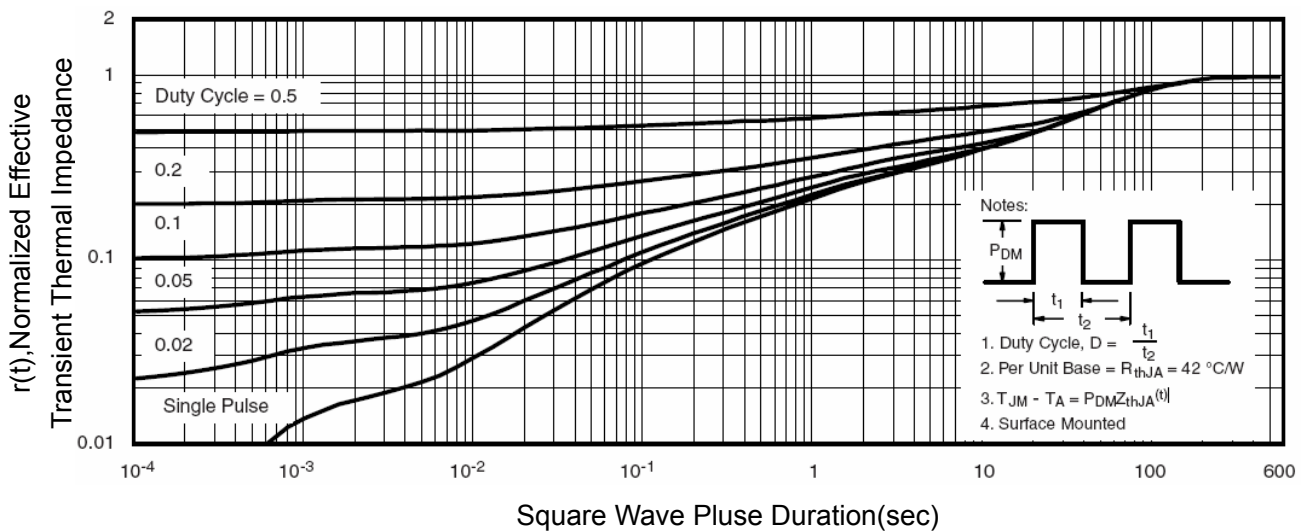
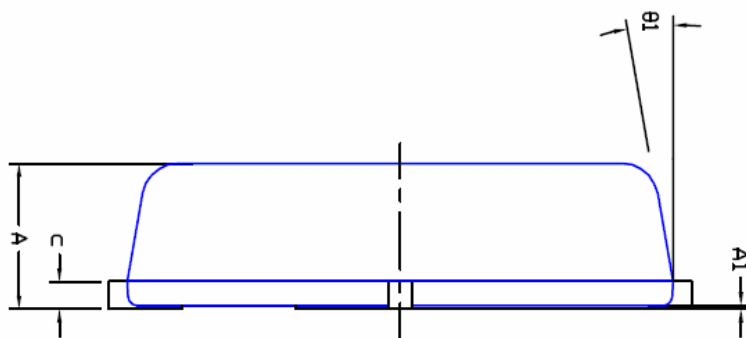
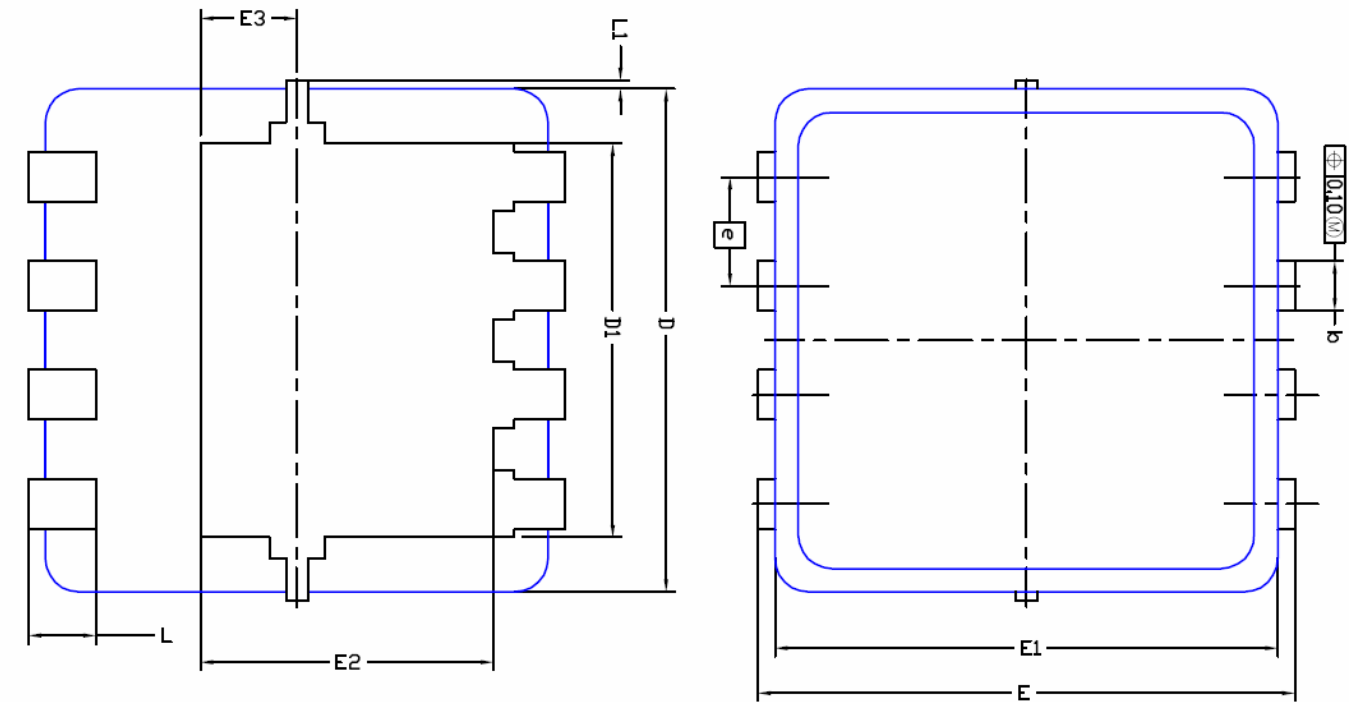


Figure 11 Normalized Maximum Transient Thermal Impedance

# DFN3X3 EP Package Information



| DIM. | MILLIMETERS |       |       | INCHES    |        |        |
|------|-------------|-------|-------|-----------|--------|--------|
|      | MIN         | NOM   | MAX   | MIN       | NOM    | MAX    |
| A    | 0,700       | 0,80  | 0,900 | 0,0276    | 0,0315 | 0,0354 |
| A1   | 0,00        | ---   | 0,05  | 0,000     | ---    | 0,002  |
| b    | 0,24        | 0,30  | 0,35  | 0,009     | 0,012  | 0,014  |
| c    | 0,10        | 0,152 | 0,25  | 0,004     | 0,006  | 0,010  |
| D    | 3,00 BSC    |       |       | 0,118 BSC |        |        |
| D1   | 2,35 BSC    |       |       | 0,093 BSC |        |        |
| E    | 3,20 BSC    |       |       | 0,126 BSC |        |        |
| E1   | 3,00 BSC    |       |       | 0,118 BSC |        |        |
| E2   | 1,75 BSC    |       |       | 0,069 BSC |        |        |
| E3   | 0,575 BSC   |       |       | 0,023 BSC |        |        |
| e    | 0,65 BSC    |       |       | 0,026 BSC |        |        |
| L    | 0,30        | 0,40  | 0,50  | 0,0118    | 0,0157 | 0,0197 |
| L1   | 0           | ---   | 0,100 | 0         | ---    | 0,004  |
| θ1   | 0°          | 10°   | 12°   | 0°        | 10°    | 12°    |